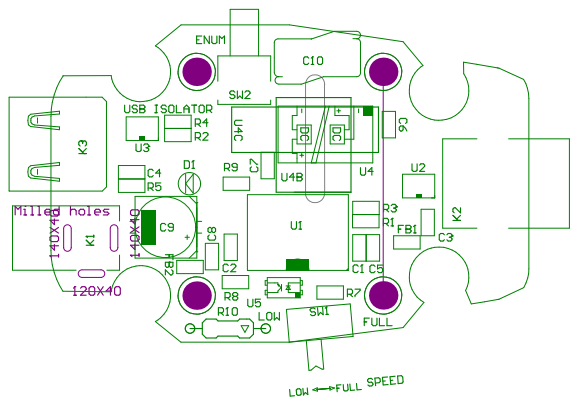


Layer Stack

Mechanical 2

Mechanical 1

Board Material : FR4 62 Mils (1.6mm) end thickness
Double sided
HASL finish - Lead free not required
Top and bottom Liquid soldermask Blue OR CHEAPEST
Top and bottom Liquid silkscreen White

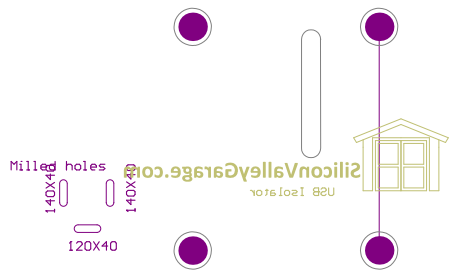
Use Keepout layer for board contour milling

Number of components	34
Number of holes	98
Number of pads	117
Number of vias	60
Printed	11/23/2012 9:09:20 AM
Scale	SCALE: 1.00

SiliconValleyGarage.com

USB Isolator

Drawn By : Vincent Himpe



Layer Stack
Mechanical 2

Bottom Overlay
Mechanical 1

Board Material : FR4 62 Mils (1.6mm) end thickness
Double sided
HASL finish - Lead free not required
Top and bottom Liquid soldermask Blue OR CHEAPEST
Top and bottom Liquid silkscreen White

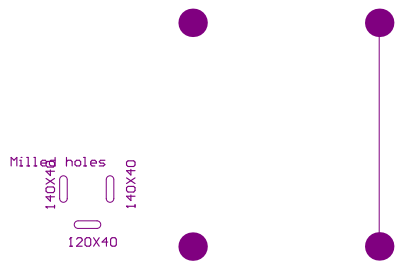
Use Keepout layer for board contour milling

Number of components	34
Number of holes	98
Number of pads	117
Number of vias	60
Printed	11/23/2012 9:09:21 AM
Scale	SCALE: 1.00

SiliconValleyGarage.com

USB Isolator

Drawn By : Vincent Himpe



Layer Stack

Mechanical 2

Mechanical 1

Board Material : FR4 62 Mils (1.6mm) end thickness
Double sided
HASL finish - Lead free not required
Top and bottom Liquid soldermask Blue OR CHEAPEST
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Number of pads	117
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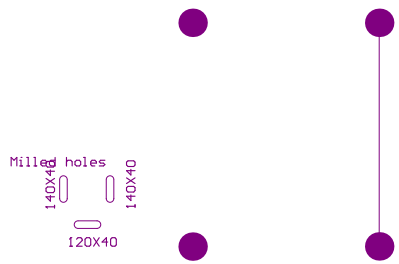
Printed	11/23/2012 9:09:21 AM
Scale	SCALE: 1.00

SiliconValleyGarage.com

USB Isolator

Drawn By : Vincent Himpe



Layer Stack

Mechanical 2

Mechanical 1

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Double sided
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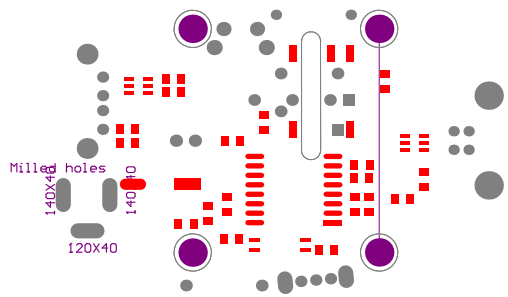
SiliconValleyGarage.com

USB Isolator

Drawn By : Vincent Himpe



Layer Stack

Mechanical 2

Mechanical 1

Board Material : FR4 62 Mils (1.6mm) end thickness
Double sided
HASL finish - Lead free not required
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Top and bottom Liquid silkscreen White

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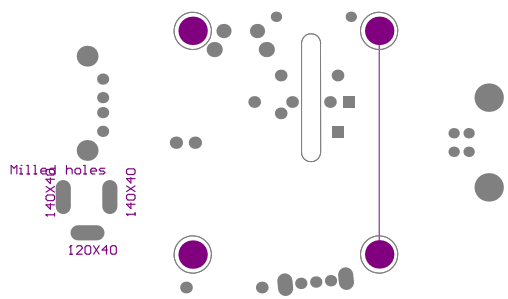
Number of pads	117
Number of vias	60
Printed	11/23/2012 9:09:21 AM
Scale	SCALE: 1.00

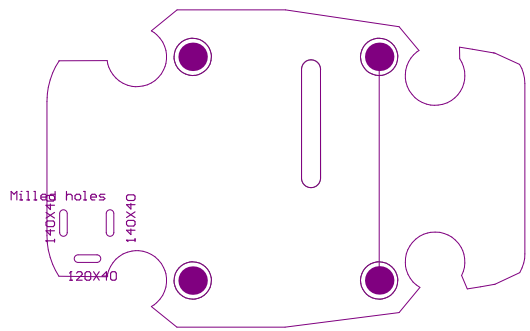
SiliconValleyGarage.com

USB Isolator

Drawn By : Vincent Himpe



Layer Stack Mechanical 2 Mechanical 1	Board Material : FR4 62 Mils (1.6mm) end thickness Double sided HASL finish - Lead free not required Top and bottom Liquid soldermask Blue OR CHEAPEST Top and bottom Liquid silkscreen White Use Keepout layer for board contour milling	Number of components Number of holes Number of pads Number of vias Printed Scale	34 98 117 60 11/23/2012 9:09:22 AM SCALE: 1.00	SiliconValleyGarage.com **USB Isolator** Drawn By : Vincent Himpe



Layer Stack

Mechanical 2

Mechanical 1

Board Material : FR4 62 Mils (1.6mm) end thickness
Double sided
HASL finish - Lead free not required
Top and bottom Liquid soldermask Blue OR CHEAPEST
Top and bottom Liquid silkscreen White

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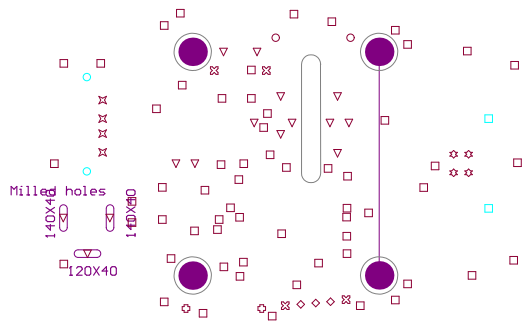
Number of pads	117
Number of vias	60
Printed	11/23/2012 9:09:22 AM
Scale	SCALE: 1.00

SiliconValleyGarage.com

USB Isolator

Drawn By : Vincent Himpe



Layer Stack

Mechanical 2

Mechanical 1

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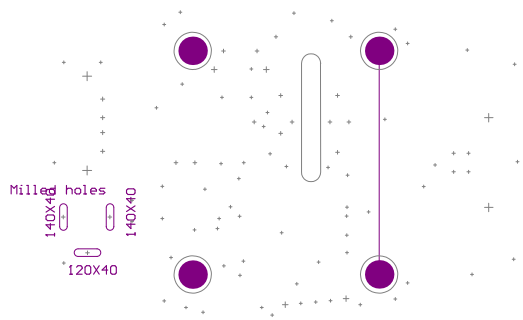
SiliconValleyGarage.com

USB Isolator

Drawn By : Vincent Himpe



Layer Stack

Mechanical 2

Mechanical 1

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SiliconValleyGarage.com

USB Isolator

Drawn By : Vincent Himpe